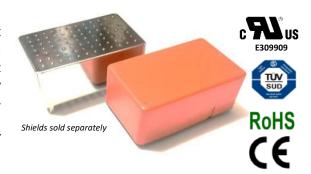
10-Watt Ultra-Wide Input Power Modules

The HPI10 series of Plug & Play 10W Power Modules support input voltages from 90-528VAC with regulated outputs from 5VDC to 24VDC. The HPI10 series offers a common footprint and meets the requirements of UL/EN 62368-1 safety standards and EMC requirements. With the option for 6-sided shielding, they are ideally suited for smart cities, building management systems, and other industrial IoT applications with wireless communications.



ORDERING CODE

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Series —————		j		1		ĺ	Ī	
HPI = High Performance Industrial Series								
Output Power			J					
10 = 10 watts								
Output Type]				
S = Single output								
First Output Voltage					J			
05, 12, 15, 18, and 24 (Vdc) options								
Second Output Voltage								
n/a								
Input Voltage Range								
E = Extended (ultra-wide) input range for 100-480\	VAC circuits							
Case Size								
D = default size								

FEATURES

- Ultra-wide input range: 90-528VAC (or 120-745VDC)
 Wide operating temperature range: -40°C to +80°C
- Isolation voltage: 4000VAC
- Built-in over current/voltage and short-circuit protection
- Integrated EMI filter for EMC compliance

R = reduced size (5V version only)

Optional 6-sided shielding

MODEL LIST

Part No.	Output Voltage	Output Current	Weight	Case Size (L x W x H)	Certificate
HPI10S0500ER	5 Vdc	2000 mA	61g	52.0 x 31.5 x 20.5	UL
HPI10S1200ED	12 Vdc	830 mA	88g		
HPI10S1500ED	15 Vdc	660 mA	88g	55.2 x 35.2 x 25.5	LIL TUV CE CD
HPI10S1800ED	18 Vdc	550 mA	88g	33.2 x 33.2 x 23.3	UL, TUV, CE, CB
HPI10S2400ED	24 Vdc	420 mA	88g		

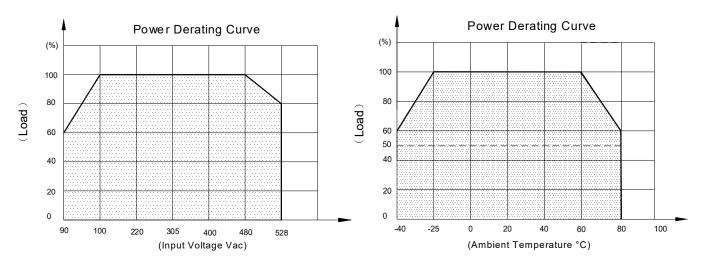


Issue Date: 2021.09.15

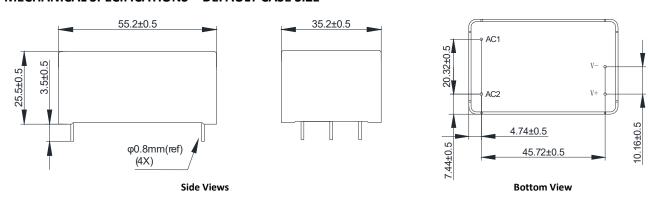
ELECTRICAL SPECIFICATIONS

	Model No.		HPI10SXX00E				
	Rated Voltage	100-480VAC & 120VDC-745VDC					
Input	Input Voltage Range	90-528VAC	90-528VAC				
	Frequency (Hz)	47-63 Hz	47-63 Hz				
		100VAC	480VAC				
	Current (Full load)	220mA	52mA				
	Inrush Current (<500us)	20A	35A				
	No Load Loss	0.5W Max	0.5W Max				
	HOT PLUG	Unavailable	Unavailable				
	Voltage (V)						
Output	Current (mA) max.	See model list					
	Voltage Accuracy	±5%	±5%				
	Line Regulation	±5%	±5%				
	Load Regulation	±5%	±5%				
	Minimum Load (mA)	0	0				
	Ripple & Noise (mV)	Vout * 3% / 20MHz bandwidth (pe	Vout * 3% / 20MHz bandwidth (peak-to-peak value)				
	Efficiency (typ.)	80% at 230VAC	80% at 230VAC				
	Set-up Time	3s	3s				
	Hold up Time	15ms min	15ms min				
5 :	Over Current Protection	Hiccup mode	Hiccup mode				
Protection	Short Circuit Protection	Hiccup mode	Hiccup mode				
	Operating Temperature	-40°C+ 80°C (see Derating Curv	-40°C+ 80°C (see Derating Curve) @Free air convection				
	Operating Humidity	10-90% RH	10-90% RH				
Environment	Storage Temperature	-40°C+85°C	-40°C+85°C				
	Storage Humidity	5-95% RH	5-95% RH				
	Temperature Coefficient	±0.04%/°C (0~60°C)	±0.04%/°C (0~60°C)				
	Case Material	Plastic (UL 94V-0)	Plastic (UL 94V-0)				
Physical	Weight	See model list					
	Dielectric Strength	I/P-O/P : 4000VAC					
	Safety Standards	Compliance with UL/EN 62368-1	Compliance with UL/EN 62368-1 (Class II)				
Safety & EMC	EMI	Compliance with EN55032 CLASS	Compliance with EN55032 CLASS B, EN61000-3-2, EN61000-3-3				
	EMS (Noise Immunity)	Conducted Susceptibility: IEC 610	Compliance with EN55035 Radiated Susceptibility: IEC 61000-4-3, 10V/m, Criteria A Conducted Susceptibility: IEC 61000-4-6, 10V (rms), Criteria A Surge: IEC 61000-4-5, line and line: 2KV, Criteria A				
Reliability	MTBF	300KHrs Min MIL-HDBK-217F(2	300KHrs Min MIL-HDBK-217F (25°C)				
Requirement	Burn-In Test	The unit shall be burned in for 2~4	The unit shall be burned in for 2~4 Hours under 500Vac input and with full load at 25°C				

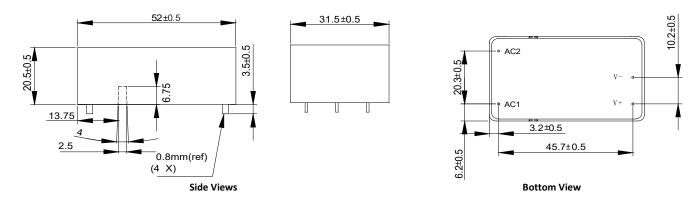
DERATING CURVES



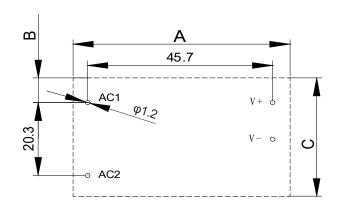
MECHANICAL SPECIFICATIONS – DEFAULT CASE SIZE



MECHANICAL SPECIFICATIONS - REDUCED CASE SIZE (available for 5Vdc only)

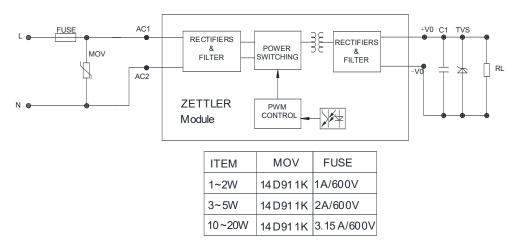


PCB LAYOUT



	Default (*ED)	Reduced (*ER)
Α	56mm	53mm
В	7.85mm	6.55mm
C	36mm	32.3mm

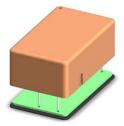
TYPICAL APPLICATION SCHEMATIC



Note: External circuit components are only recommendations, customers should choose their own components and values according to their specific system application requirements.

SHIELDING

The base of HPI10 power modules integrate a shield plane allowing system designers to easily implement 6-sided shielding. An optional top shield can be added and bonded to digital ground (-VO) in order to minimize radiated noise from the power supply interfering with sensitive communications receivers.



Contact ZETTLER for bundling a shield with the HPI10 power module or to obtain 3D files. If designing your own shield, creepages and clearances around the AC input need to be considered.